IN THE UNITED STATES I

IN RE APPLICATION OF:

SERIAL NO: 10/718,535 Yasuii HIRAMATSU, et al.

GAU:

1725

FILED:

November 24, 2003

EXAMINER:

RADEMARK OFFICE

FOR:

SEMICONDUCTOR-PRODUCING/EXAMINING DEVICE

INFORMATION DISCLOSURE STATEMENT UNDER 37 CFR 1.97

COMMISSIONER FOR PATENTS ALEXANDRIA, VIRGINIA 22313

SIR:

Applicant(s) wish to disclose the following information.

REFERENCES

The applicant(s) wish to make of record the references listed on the attached form PTO-1449. Copies of the listed
references are attached, where required, as are either statements of relevancy or any readily available English
translations of pertinent portions of any non-English language references.

A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

RELATED CASES

Attached is a list of applicant's pending application(s), published application(s) or issued patent(s) which may be related to the present application. In accordance with the waiver of 37 CFR 1.98 dated September 21, 2004, copies of the cited pending applications are not provided. Cited published and/or issued patents, if any, are listed on the attached PTO form 1449.

☐ A check or credit card payment form is attached in the amount required under 37 CFR §1.17(p).

CERTIFICATION

☐ Each item of information contained in this information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than three months prior to the filing of this statement.

☐ No item of information contained in this information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned, having made reasonable inquiry, was known to any individual designated in 37 CFR §1.56(c) more than three months prior to the filing of this statement.

DEPOSIT ACCOUNT

Please charge any additional fees for the papers being filed herewith and for which no check or credit card payment is enclosed herewith, or credit any overpayment to deposit account number 15-0030. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

OBLON, SPIVAK, McCLELLAND,

MAIER & NEUSTADT, P.C

Masayasu Mofi

Registration No. 47,301

Customer Number

Tel. (703) 413-3000 Fax. (703) 413-2220 (OSMMN 05/03)

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(Modified) PATENT AND TRADEMARK OFFICE			245199US90CONT 10/718,539		535			
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LIST OF	REFE	RENCES CITED BY AP	PLICANT %	Yasuji HIRAMATSU, et al.				
		NEC	0 2 2004	FILING DATE		GROUP		
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		(Ovr.	PRADEMARY	U.S. PATENT DOCUMENTS				
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS		ILING DATE PPROPRIATE
	AA	2003-0104186	06/05/03	ITO				
	AB	2001-0040158	11/15/01	SAITO et al.				
	AC	2001-0042745	11/22/01	SAITO et al.				
	AD	2002-0043527	04/18/02	ІТО				
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	AG	2003-0000937	01/02/03	ІТО				
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	AJ	2002-0180466	12/05/02	HIRAMATSU et al.				·
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	AA	2003-0062358	04/03/03	ITO et al.				
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	AA	2003-0044589	03/06/03	NIWA				
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^{*}Present Application; listed for information MM/sch
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